

TrenchP[™] Power MOSFETs

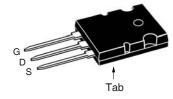
IXTK120P20T IXTX120P20T

P-Channel Enhancement Mode Avalanche Rated Fast Intrinsic Rectifier

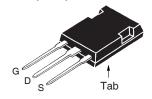


$V_{\scriptscriptstyle DSS}$	=	- 200V
I _{D25}	=	- 120A
R _{DS(on)}	≤	$30 \mathrm{m}\Omega$
t _{rr}	≤	300ns

TO-264 (IXTK)



PLUS247 (IXTX)



G = Gate	D = Drain
S = Source	Tab = Drain

Features

- International Standard Packages
- Avalanche Rated
- Extended FBSOA
- Fast Intrinsic Recitifier
- Low $R_{DS(ON)}$ and Q_{G}

Advantages

- Easy to Mount
- Space Savings
- High Power Density

Applications

- High-Side Switching
- Push Pull Amplifiers
- DC Choppers
- Automatic Test Equipment
- Current Regulators
- Battery Charger Applications

Symbol	Test Conditions	Maximum F	Ratings
V _{DSS}	T _{_1} = 25°C to 150°C	- 200	V
V _{DGR}	$T_J = 25$ °C to 150°C, $R_{GS} = 1M\Omega$	- 200	V
V _{GSS}	Continuous	±15	V
V _{GSM}	Transient	±25	V
I _{D25}	T _c = 25°C	-120	A
I _{DM}	$T_{\rm C} = 25^{\circ}$ C, Pulse Width Limited by $T_{\rm JM}$	- 400	Α
I _A E _{AS}	$T_c = 25^{\circ}C$ $T_c = 25^{\circ}C$	-100 3	A J
dv/dt	$I_{_{\mathrm{S}}} \leq I_{_{\mathrm{DM}}}, V_{_{\mathrm{DD}}} \leq V_{_{\mathrm{DSS}}}, T_{_{\mathrm{J}}} \leq 150^{\circ}\mathrm{C}$	10	V/ns
P_{D}	T _C = 25°C	1040	W
T _J T _{JM} T _{stg}		-55 +150 150 -55 +150	0° 0° 0°
T _L T _{SOLD}	Maximum Lead Temperature for Soldering 1.6 mm (0.062in.) from Case for 10s	300 260	°C °C
M _d	Mounting Torque (TO-264)	1.13/10	Nm/lb.in.
F _c	Mounting Force (PLUS247)	20120 /4.527	N/lb.
Weight	TO-264 PLUS247	10 6	g g

SymbolTest ConditionsCharacteristics $(T_J = 25^{\circ}\text{C Unless Otherwise Specified})$ Min.		cteristic Values Typ. Max.			
BV _{DSS}	$V_{GS} = 0V, I_{D} = -250\mu A$	- 200			V
V _{GS(th)}	$V_{DS} = V_{GS}$, $I_D = -250\mu A$	- 2.5		- 4.5	V
I _{GSS}	$V_{GS} = \pm 15V, V_{DS} = 0V$			±200	nA
I _{DSS}	$V_{DS} = V_{DSS}, V_{GS} = 0V$ $T_{J} = 1$	25°C		- 25 - 300	•
R _{DS(on)}	$V_{GS} = -10V, I_{D} = 0.5 \cdot I_{D25}, Note 1$			30	mΩ



SymbolTest ConditionsCharacter(T ₁ = 25°C Unless Otherwise Specified)Min.		teristic Values Typ. Max.			
g _{fs}		V _{DS} = -10V, I _D = -60A, Note 1	85	145	S
C _{iss})			73	nF
C _{oss}	}	$V_{GS} = 0V, V_{DS} = -25V, f = 1MHz$		2550	pF
\mathbf{C}_{rss}	J			480	pF
t _{d(on)})			90	ns
t,		Resistive Switching Times		85	ns
t _{d(off)}	1	$V_{GS} = -10V, V_{DS} = 0.5 \cdot V_{DSS}, I_{D} = 0.5 \cdot I_{D25}$		200	ns
t _f	J	$R_{_{G}} = 1\Omega$ (External)		50	ns
$\mathbf{Q}_{g(on)}$)			740	nC
Q_{gs}	}	$V_{GS} = -10V, V_{DS} = 0.5 \cdot V_{DSS}, I_{D} = 0.5 \cdot I_{D25}$		220	nC
\mathbf{Q}_{gd}	J			120	nC
R _{thJC}					0.12 °C/W
R _{thCS}				0.15	°C/W

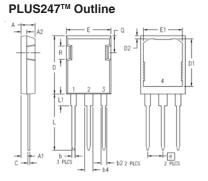
Source-Drain Diode

SymbolTest ConditionsChara $(T_J = 25^{\circ}\text{C Unless Otherwise Specified})$ Min.			cteristic Typ.	Values Max.	
I _s	$V_{GS} = 0V$			-120	Α
I _{sm}	Repetitive, Pulse Width Limited by $T_{_{\rm JM}}$			- 480	Α
V _{SD}	$I_{\rm F} = -100 {\rm A}, \ V_{\rm GS} = 0 {\rm V}, \ {\rm Note} \ 1$			-1.4	V
$\left\{ egin{array}{c} \mathbf{t}_{rr} \\ \mathbf{Q}_{RM} \\ \mathbf{I}_{RM} \end{array} \right\}$	$I_F = -60A$, $-di/dt = -100A/\mu s$ $V_R = -100V$, $V_{GS} = 0V$		3.3 25.6	300	ns µC A

Note

1. Pulse test, $t \le 300\mu s$, duty cycle, $d \le 2\%$.

TO-264 AA Outline ⊕ 1@ c v Ø 1 - Gate 2,4 - Drain BACK SIDE 3 - Source -A-- ¢P⊕ØK®DB® MILLIMETERS INCHES MAX 5.31 3.00 1.40 SYMBOL MIN MAX MIN .209 2.59 0.94 A1 b b1 .087 .110 .017 1.007 .102 .126 .029 1.047 25.58 26 19.30 2 5.46 BSC 26.59 799 .000 .000 .779 0.00 .010 .010 19.79 .087 øP1 .290 6.86 6.50 8.79 4.75 2.36 6.10 8.38 Q Q1 .240 .256 .346



.187 .093 .253

.243

ØR ØR1 3.94 2.16

Terminals: 1 - Gate 2,4 - Drain 3 - Source

SYM	INCHES		MILLIMETERS		
SIM	MIN	MAX	MIN	MAX	
Α	.190	.205	4.83	5.21	
A1	.090	.100	2.29	2.54	
A2	.075	.085	1.91	2.16	
Ь	.045	.055	1.14	1.40	
b2	.075	.087	1.91	2.20	
b4	.115	.126	2.92	3,20	
С	.024	.031	0.61	0.80	
D	.819	.840	20.80	21.34	
D1	.650	.690	16.51	17.53	
D2	.035	.050	0.89	1.27	
Ε	.620	.635	15.75	16.13	
Ē1	.520	.560	13.08	14.22	
е	.215	.215 BSC		BSC	
L	.780	.810	19.81	20.57	
L1	.150	.170	3.81	4.32	
Q	,220	.244	5,59	6,20	
R	.170	.190	4.32	4,83	



Fig. 1. Output Characteristics @ T_J = 25°C

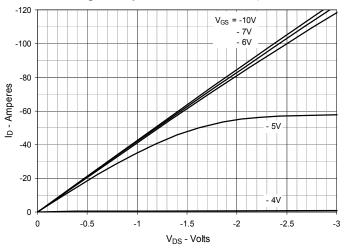


Fig. 2. Extended Output Characteristics @ T_J = 25°C

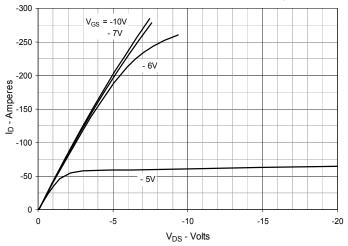


Fig. 3. Output Characteristics @ T_J = 125°C

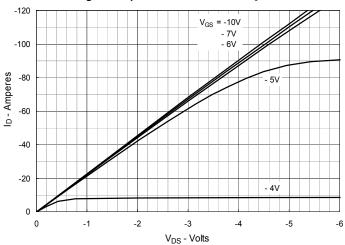


Fig. 4. $R_{DS(on)}$ Normalized to $I_D = -60A$ Value vs. Junction Temperature

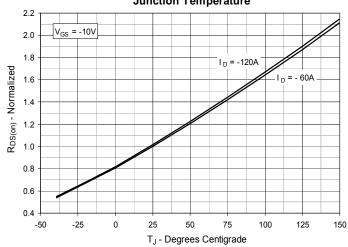


Fig. 5. $R_{DS(on)}$ Normalized to $I_D = -60A$ Value vs.

Drain Current

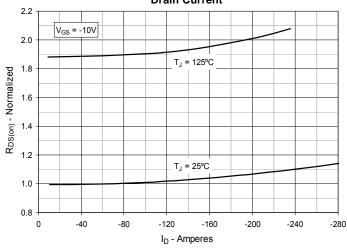
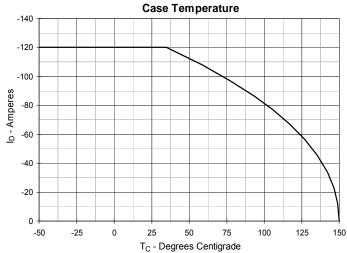
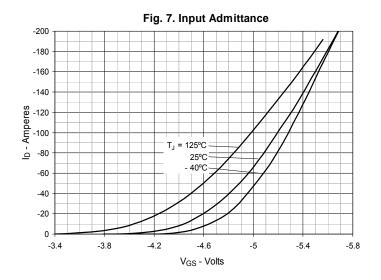
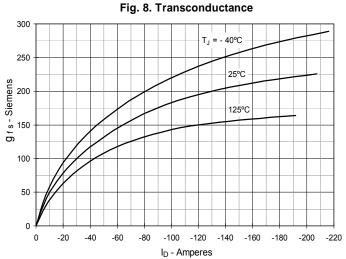


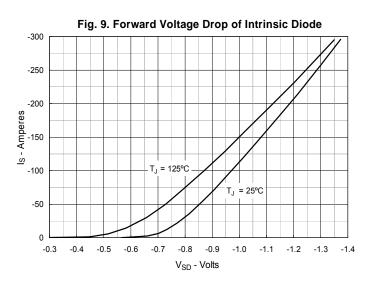
Fig. 6. Maximum Drain Current vs.

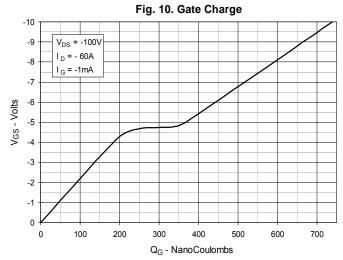


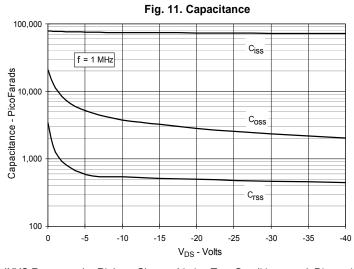


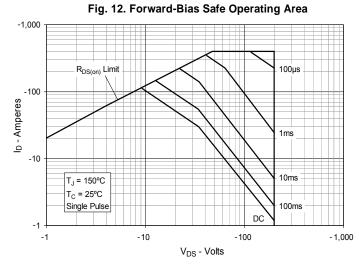












IXYS Reserves the Right to Change Limits, Test Conditions, and Dimensions.



Fig. 13. Resistive Turn-on Rise Time vs. Junction Temperature

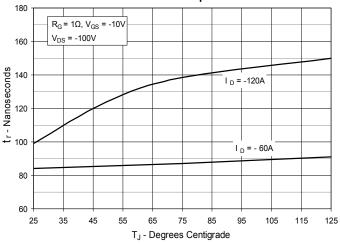


Fig. 14. Resistive Turn-on Rise Time vs.

Drain Current

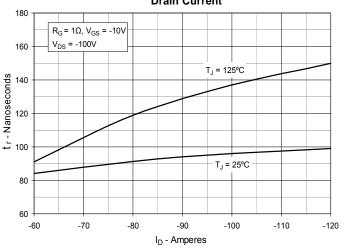


Fig. 15. Resistive Turn-on Switching Times vs.
Gate Resistance

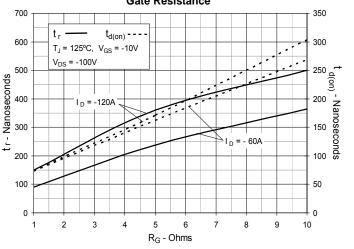


Fig. 16. Resistive Turn-off Switching Times vs.
Junction Temperature

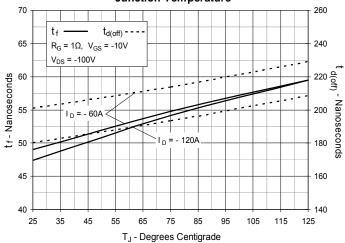


Fig. 17. Resistive Turn-off Switching Times vs.

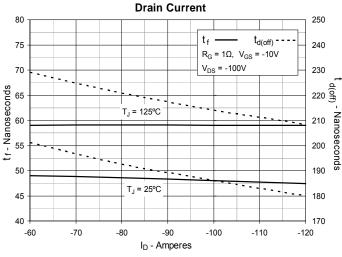
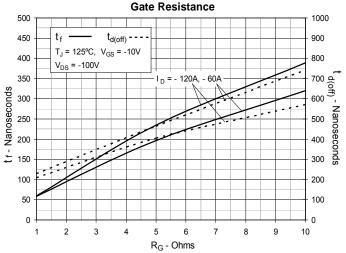


Fig. 18. Resistive Turn-off Switching Times vs.





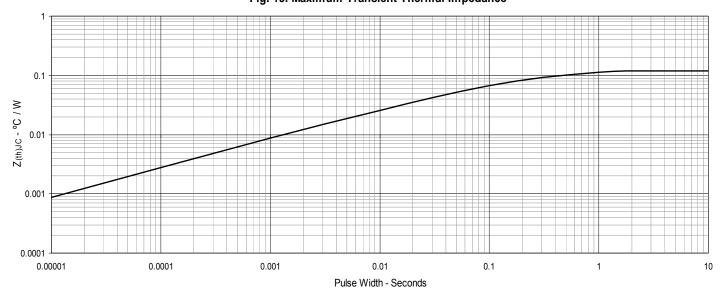


Fig. 19. Maximum Transient Thermal Impedance